



# STGB20NB32LZ STGB20NB32LZ-1

N-CHANNEL CLAMPED 20A - D<sup>2</sup>PAK/I<sup>2</sup>PAK  
INTERNALLY CLAMPED PowerMESH™ IGBT

| TYPE           | V <sub>CES</sub> | V <sub>CE(sat)</sub> | I <sub>C</sub> |
|----------------|------------------|----------------------|----------------|
| STGB20NB32LZ   | CLAMPED          | < 2.0 V              | 20 A           |
| STGB20NB32LZ-1 | CLAMPED          | < 2.0 V              | 20 A           |

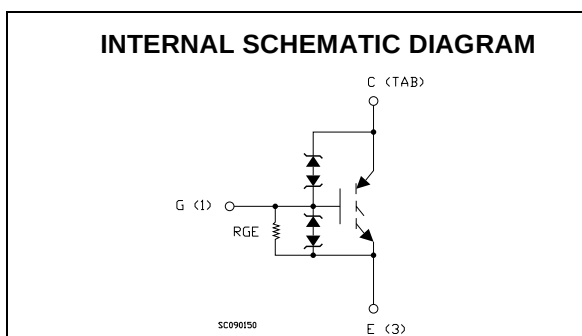
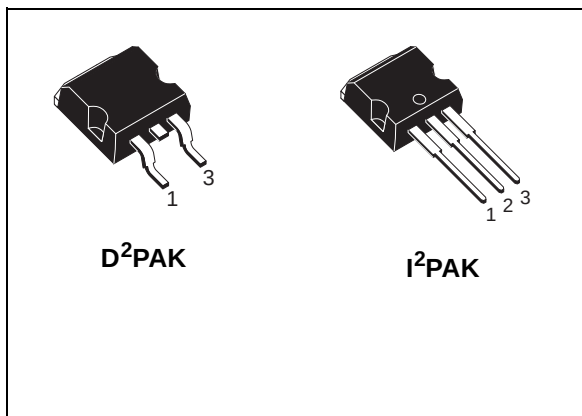
- POLYSILICON GATE VOLTAGE DRIVEN
- LOW THRESHOLD VOLTAGE
- LOW ON-VOLTAGE DROP
- HIGH CURRENT CAPABILITY
- HIGH VOLTAGE CLAMPING FEATURE

## DESCRIPTION

Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESH™ IGBTs, with outstanding performances. The built in collector-gate zener exhibits a very precise active clamping while the gate-emitter zener supplies an ESD protection.

## APPLICATIONS

- ELECTRONIC IGNITION FOR AUTOMOTIVE



## ORDERING INFORMATION

| SALES TYPE     | MARKING    | PACKAGE            | PACKAGING   |
|----------------|------------|--------------------|-------------|
| STGB20NB32LZT4 | GB20NB32LZ | D <sup>2</sup> PAK | TAPE & REEL |
| STGB20NB32LZ-1 | GB20NB32LZ | I <sup>2</sup> PAK | TUBE        |

**STGB20NB32LZ - STGB20NB32LZ-1****ABSOLUTE MAXIMUM RATINGS**

| Symbol            | Parameter                                                   | Value      | Unit                |
|-------------------|-------------------------------------------------------------|------------|---------------------|
| $V_{CES}$         | Collector-Emitter Voltage ( $V_{GS} = 0$ )                  | CLAMPED    | V                   |
| $V_{ECR}$         | Reverse Battery Protection                                  | 20         | V                   |
| $V_{GE}$          | Gate-Emitter Voltage                                        | CLAMPED    | V                   |
| $I_C$             | Collector Current (continuous) at $T_c = 25^\circ\text{C}$  | 40         | A                   |
| $I_C$             | Collector Current (continuous) at $T_c = 100^\circ\text{C}$ | 30         | A                   |
| $I_{CM}(\bullet)$ | Collector Current (pulsed)                                  | 80         | A                   |
| $E_{as}$          | Single Pulse Energy $T_c = 25^\circ\text{C}$                | 700        | mJ                  |
| $P_{tot}$         | Total Dissipation at $T_c = 25^\circ\text{C}$               | 150        | W                   |
|                   | Derating Factor                                             | 1          | W/ $^\circ\text{C}$ |
| $E_{SD}$          | ESD (Human Body Model)                                      | 4          | KV                  |
| $T_{stg}$         | Storage Temperature                                         | -65 to 175 | $^\circ\text{C}$    |
| $T_j$             | Max. Operating Junction Temperature                         | 175        | $^\circ\text{C}$    |

( $\bullet$ )Pulse width limited by safe operating area

**THERMAL DATA**

|                |                                         |      |                    |
|----------------|-----------------------------------------|------|--------------------|
| $R_{thj-case}$ | Thermal Resistance Junction-case Max    | 1    | $^\circ\text{C/W}$ |
| $R_{thj-amb}$  | Thermal Resistance Junction-ambient Max | 62.5 | $^\circ\text{C/W}$ |

**ELECTRICAL CHARACTERISTICS ( $T_{CASE} = 25^\circ\text{C}$  UNLESS OTHERWISE SPECIFIED)**

OFF

| Symbol       | Parameter                                     | Test Conditions                                              | Min.      | Typ.      | Max.       | Unit          |
|--------------|-----------------------------------------------|--------------------------------------------------------------|-----------|-----------|------------|---------------|
| $BV_{(CES)}$ | Clamped Voltage                               | $I_C = 2\text{ mA}, V_{GE} = 0, T_c = -40^\circ\text{C}$     | 330       | 355       | 380        | V             |
|              |                                               | $I_C = 2\text{ mA}, V_{GE} = 0, T_c = 25^\circ\text{C}$      | 325       | 350       | 375        | V             |
|              |                                               | $I_C = 2\text{ mA}, V_{GE} = 0, T_c = 150^\circ\text{C}$     | 320       | 345       | 370        | V             |
| $BV_{(ECR)}$ | Emitter Collector Break-down Voltage          | $I_C = 75\text{ mA}, T_c = 25^\circ\text{C}$                 | 20        | 28        |            | V             |
| $BV_{GE}$    | Gate Emitter Break-down Voltage               | $I_G = \pm 2\text{ mA}$                                      | 12        | 14        | 16         | V             |
| $I_{CES}$    | Collector cut-off Current ( $V_{GE} = 0$ )    | $V_{CE} = 15\text{ V}, V_{GE} = 0, T_c = 150^\circ\text{C}$  |           |           | 10         | $\mu\text{A}$ |
|              |                                               | $V_{CE} = 200\text{ V}, V_{GE} = 0, T_c = 150^\circ\text{C}$ |           |           | 100        | $\mu\text{A}$ |
| $I_{GES}$    | Gate-Emitter Leakage Current ( $V_{CE} = 0$ ) | $V_{GE} = \pm 10\text{ V}, V_{CE} = 0$                       | $\pm 400$ | $\pm 660$ | $\pm 1000$ | $\mu\text{A}$ |
| $R_{GE}$     | Gate Emitter Resistance                       |                                                              | 10        | 15        | 25         | K $\Omega$    |

ON (1)

| Symbol        | Parameter                            | Test Conditions                                                     | Min. | Typ. | Max. | Unit |
|---------------|--------------------------------------|---------------------------------------------------------------------|------|------|------|------|
| $V_{GE(th)}$  | Gate Threshold Voltage               | $V_{CE} = V_{GE}, I_C = 250\mu\text{A}, T_c = -40^\circ\text{C}$    | 1.2  |      |      | V    |
|               |                                      | $V_{CE} = V_{GE}, I_C = 250\mu\text{A}, T_c = 25^\circ\text{C}$     | 1    | 1.4  | 2    | V    |
|               |                                      | $V_{CE} = V_{GE}, I_C = 250\mu\text{A}, T_c = 150^\circ\text{C}$    | 0.6  |      |      | V    |
| $V_{CE(SAT)}$ | Collector-Emitter Saturation Voltage | $V_{GE} = 4.5\text{ V}, I_C = 10\text{ A}, T_c = 25^\circ\text{C}$  |      | 1.1  | 1.8  | V    |
|               |                                      | $V_{GE} = 4.5\text{ V}, I_C = 10\text{ A}, T_c = 150^\circ\text{C}$ |      | 1    | 1.7  | V    |
|               |                                      | $V_{GE} = 4.5\text{ V}, I_C = 20\text{ A}, T_c = 25^\circ\text{C}$  |      | 1.35 | 2    | V    |
|               |                                      | $V_{GE} = 4.5\text{ V}, I_C = 20\text{ A}, T_c = 150^\circ\text{C}$ |      | 1.25 | 2    | V    |

**ELECTRICAL CHARACTERISTICS** ( $T_{CASE} = 25\text{ }^{\circ}\text{C}$  UNLESS OTHERWISE SPECIFIED)  
DYNAMIC

| Symbol    | Parameter                    | Test Conditions                                                          | Min. | Typ. | Max. | Unit |
|-----------|------------------------------|--------------------------------------------------------------------------|------|------|------|------|
| $g_{fs}$  | Forward Transconductance     | $V_{CE} = 25\text{ V}$ , $I_C = 20\text{ A}$                             |      | 35   |      | S    |
| $C_{ies}$ | Input Capacitance            | $V_{CE} = 25\text{ V}$ , $f = 1\text{ MHz}$ , $V_{GE} = 0$               |      | 2300 |      | pF   |
| $C_{oes}$ | Output Capacitance           |                                                                          |      | 165  |      | pF   |
| $C_{res}$ | Reverse Transfer Capacitance |                                                                          |      | 28   |      | pF   |
| $Q_g$     | Gate Charge                  | $V_{CE} = 280\text{ V}$ , $I_C = 20\text{ A}$ ,<br>$V_{GE} = 5\text{ V}$ |      | 51   |      | nC   |

**FUNCTIONAL CHARACTERISTICS**

| Symbol | Parameter                           | Test Conditions                                                                                                                    | Min. | Typ. | Max. | Unit |
|--------|-------------------------------------|------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| II     | Latching Current                    | $R_{G\text{OFF}} = 127\Omega$ , $V_{\text{Clamp}} = 250\text{ V}$ ,<br>$V_{GE} = 5\text{ V}$ , $T_C = 125\text{ }^{\circ}\text{C}$ | 34   |      |      | A    |
| U.I.S. | Functional Test Open Secondary Coil | $R_{G\text{OFF}} = 1\text{ K}\Omega$ , $T_C = 125\text{ }^{\circ}\text{C}$ , $V_G = 5\text{ V}$ ,<br>$L = 1.6\text{ mH}$           | 21.6 |      |      | A    |

**SWITCHING ON**

| Symbol                      | Parameter                | Test Conditions                                                                                                                                                                | Min. | Typ.       | Max. | Unit                           |
|-----------------------------|--------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------------|------|--------------------------------|
| $t_{d(\text{on})}$<br>$t_r$ | Delay Time<br>Rise Time  | $V_{CC} = 250\text{ V}$ , $I_C = 20\text{ A}$<br>$R_G = 1\text{ K}\Omega$ , $V_{GE} = 4.5\text{ V}$                                                                            |      | 2.3<br>0.6 |      | $\mu\text{s}$<br>$\mu\text{s}$ |
| $(di/dt)_{\text{on}}$       | Turn-on Current Slope    | $V_{CC} = 250\text{ V}$ , $I_C = 20\text{ A}$<br>$R_G = 1\text{ K}\Omega$ , $V_{GE} = 4.5\text{ V}$                                                                            |      | 550        |      | A/ $\mu\text{s}$               |
| $E_{\text{on}}$             | Turn-on Switching Losses | $V_{CC} = 250\text{ V}$ , $I_C = 20\text{ A}$ , $T_C = 25\text{ }^{\circ}\text{C}$<br>$R_G = 1\text{ K}\Omega$ , $V_{GE} = 4.5\text{ V}$ , $T_C = 150\text{ }^{\circ}\text{C}$ |      | 8.8<br>9.2 |      | mJ<br>mJ                       |

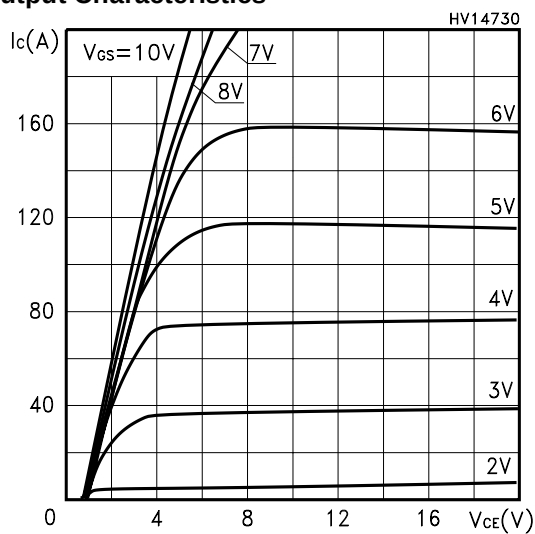
**SWITCHING OFF**

| Symbol                                                                                    | Parameter                                                                                                  | Test Conditions                                                                                                                                 | Min. | Typ. | Max. | Unit          |
|-------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|---------------|
| $t_c$<br>$t_r(V_{\text{off}})$<br>$t_f$<br>$t_{d(\text{off})}$<br>$E_{\text{off}}^{(**)}$ | Cross-Over Time<br>Off Voltage Rise Time<br>Fall Time<br>Off Voltage Delay Time<br>Turn-off Switching Loss | $V_{CC} = 250\text{ V}$ , $I_C = 20\text{ A}$ ,<br>$R_{GE} = 1\text{ K}\Omega$ , $V_{GE} = 4.5\text{ V}$                                        |      | 4.8  |      | $\mu\text{s}$ |
|                                                                                           |                                                                                                            |                                                                                                                                                 |      | 2.6  |      | $\mu\text{s}$ |
|                                                                                           |                                                                                                            |                                                                                                                                                 |      | 2    |      | $\mu\text{s}$ |
|                                                                                           |                                                                                                            |                                                                                                                                                 |      | 11.5 |      | $\mu\text{s}$ |
|                                                                                           |                                                                                                            |                                                                                                                                                 |      | 11.8 |      | mJ            |
| $t_c$<br>$t_r(V_{\text{off}})$<br>$t_f$<br>$t_{d(\text{off})}$<br>$E_{\text{off}}^{(**)}$ | Cross-Over Time<br>Off Voltage Rise Time<br>Fall Time<br>Off Voltage Delay Time<br>Turn-off Switching Loss | $V_{CC} = 250\text{ V}$ , $I_C = 20\text{ A}$ ,<br>$R_{GE} = 1\text{ K}\Omega$ , $V_{GE} = 4.5\text{ V}$<br>$T_C = 150\text{ }^{\circ}\text{C}$ |      | 7.8  |      | $\mu\text{s}$ |
|                                                                                           |                                                                                                            |                                                                                                                                                 |      | 3.5  |      | $\mu\text{s}$ |
|                                                                                           |                                                                                                            |                                                                                                                                                 |      | 3.9  |      | $\mu\text{s}$ |
|                                                                                           |                                                                                                            |                                                                                                                                                 |      | 12   |      | $\mu\text{s}$ |
|                                                                                           |                                                                                                            |                                                                                                                                                 |      | 17.8 |      | mJ            |

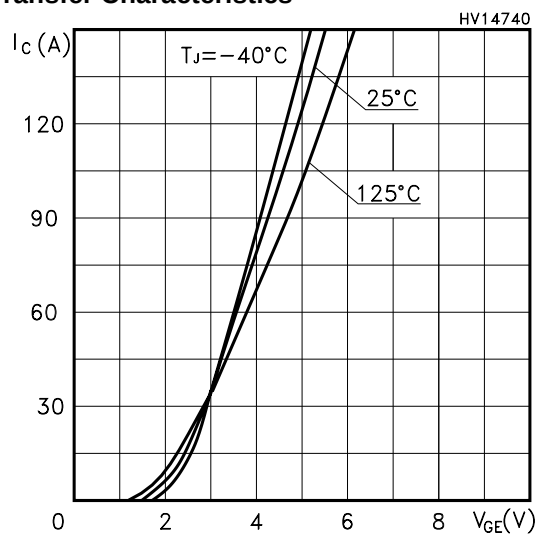
(\*\*) Losses Include Also the Tail (jedec Standardization)

## STGB20NB32LZ - STGB20NB32LZ-1

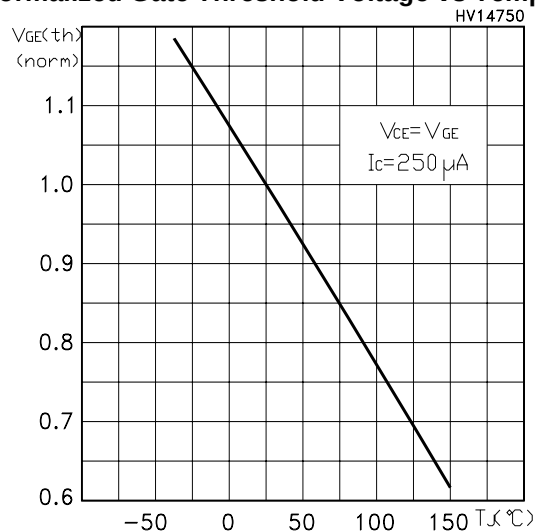
### Output Characteristics



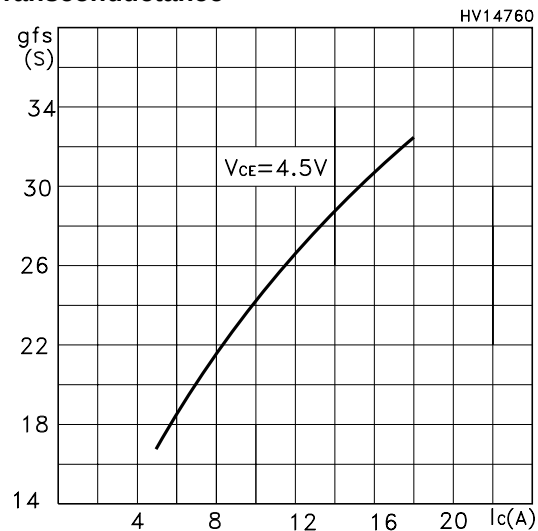
### Transfer Characteristics



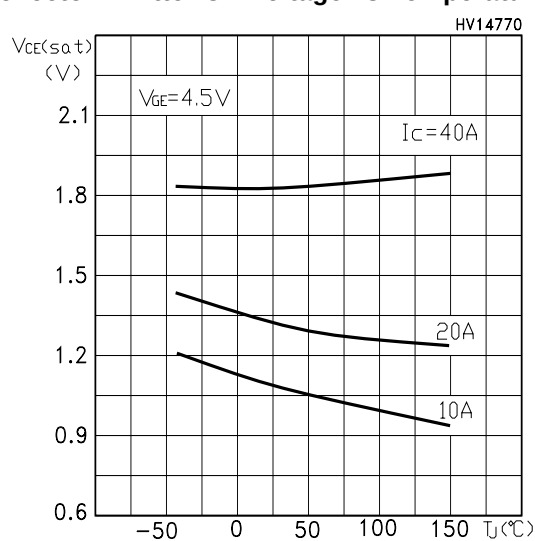
### Normalized Gate Threshold Voltage vs Temp.



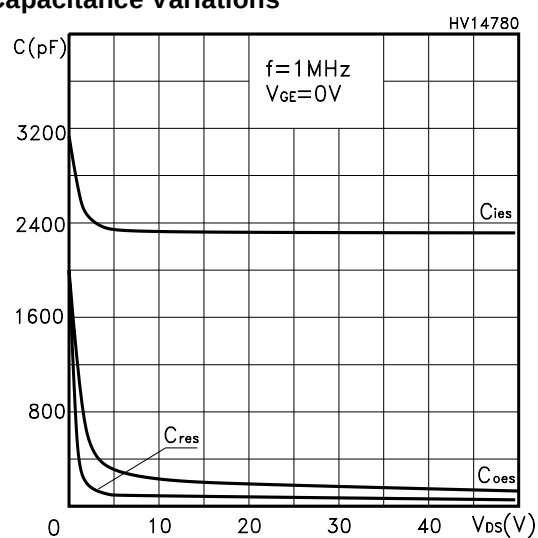
### Transconductance



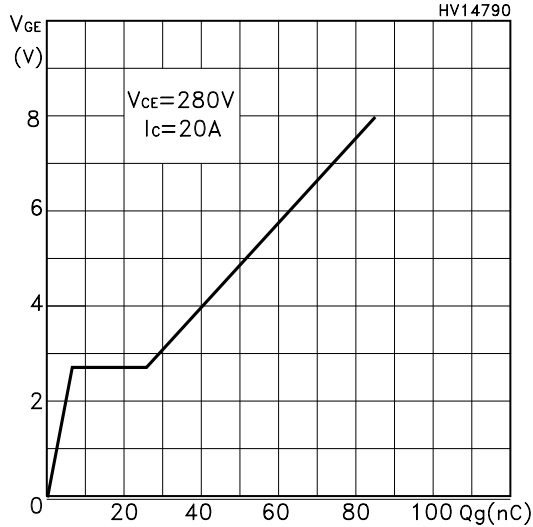
### Collector-Emitter On Voltage vs Temperature



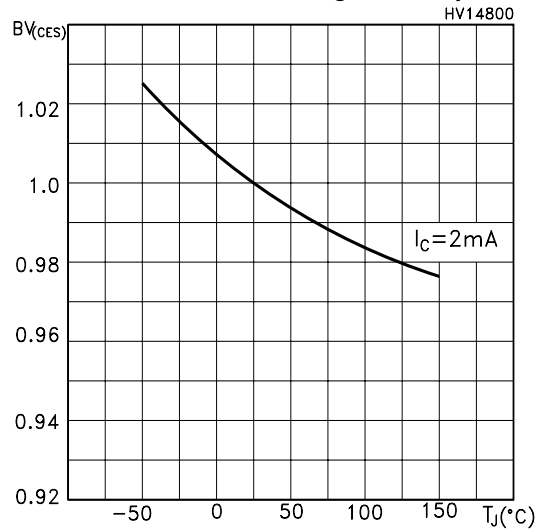
### Capacitance Variations



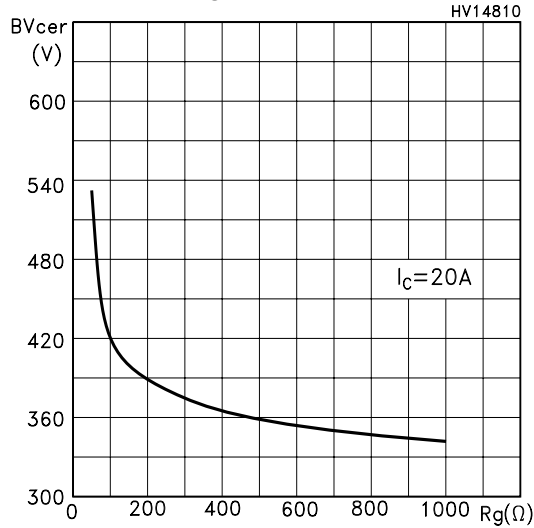
Gate Charge vs Gate-Emitter Voltage



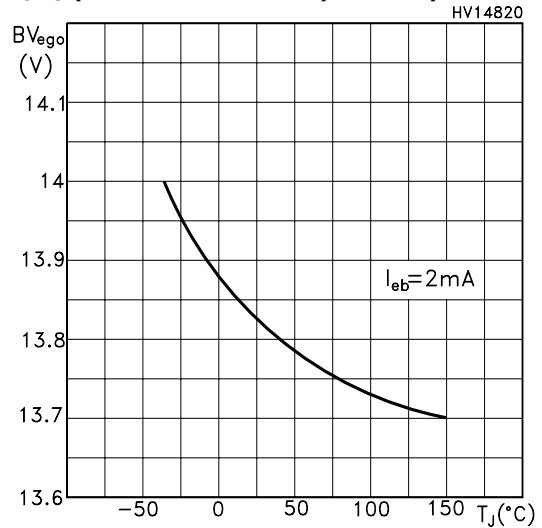
Normalized BreakDown Voltage vs Temperature



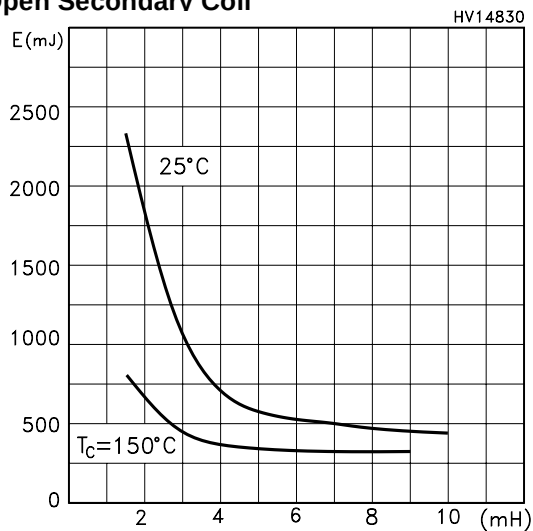
Break-Down Voltage vs Emitter Resistance



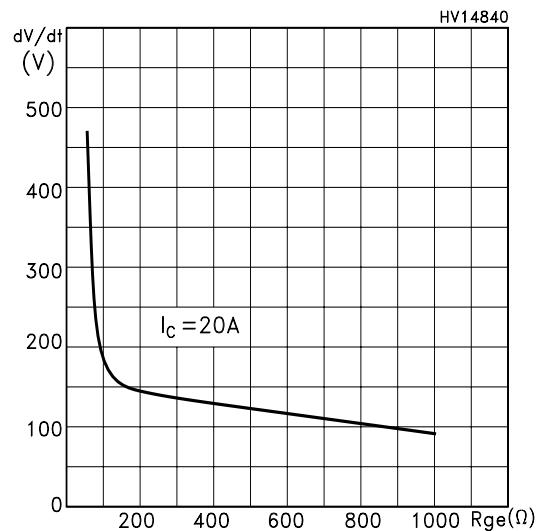
$BV_{GEO}$  (Zener Gate-Emitter) vs Temperature



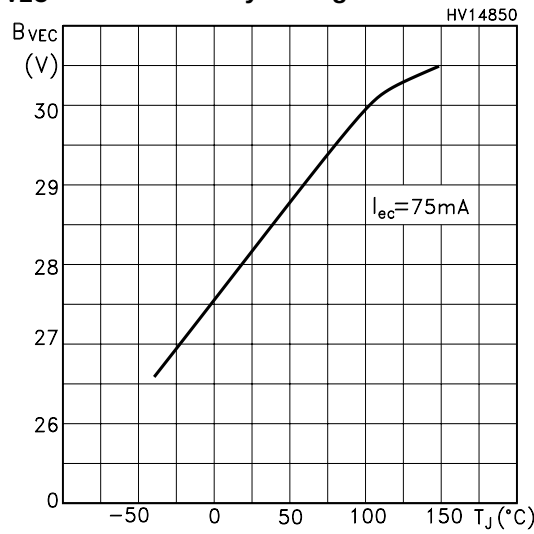
Self Clamped Inductive Switching Energy vs Open Secondary Coil



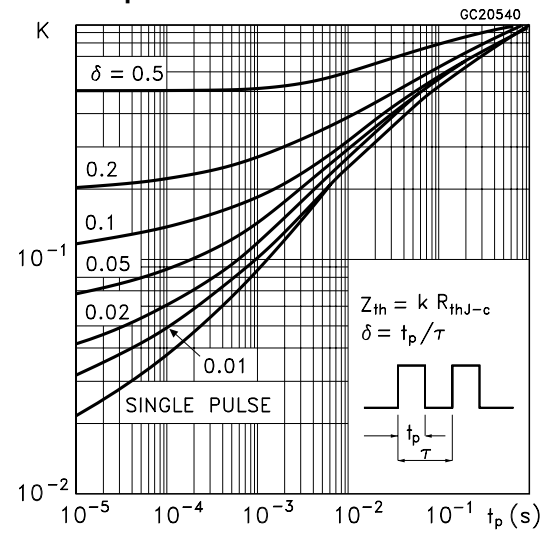
dV/dt Gate-Emitter Resistance



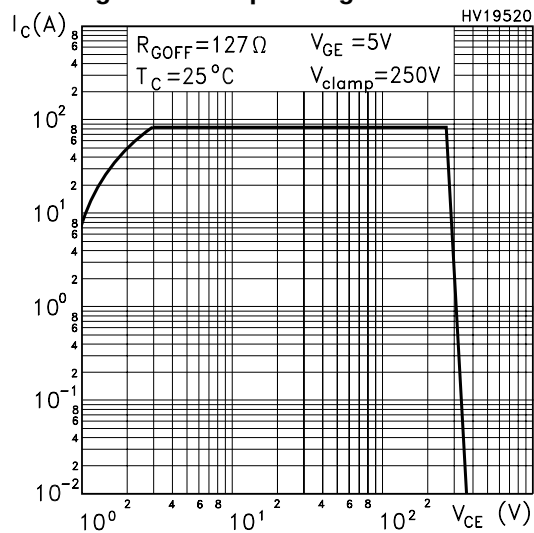
**B<sub>VEC</sub> Reverse Battery Voltage**



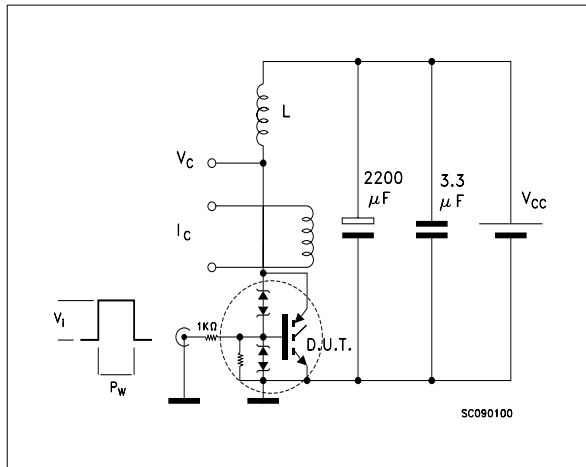
**Thermal Impedance**



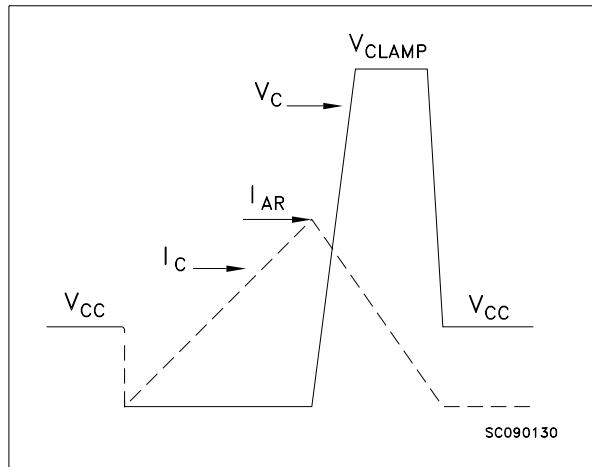
**Switching Off Safe Operating Area**



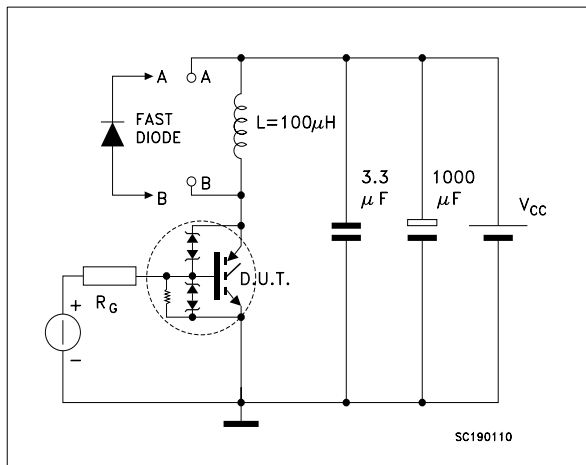
**Fig. 1: Unclamped Inductive Load Test Circuit**



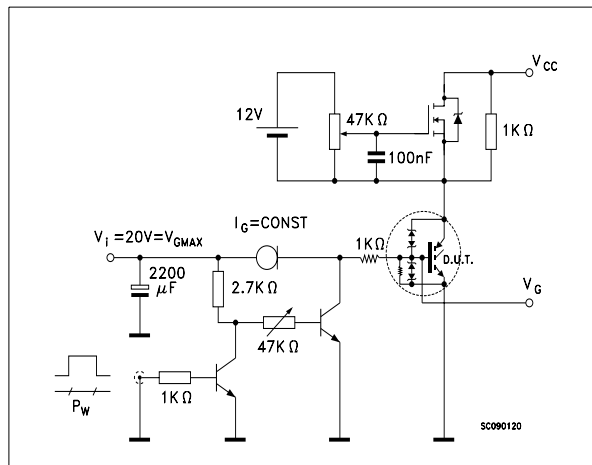
**Fig. 2: Unclamped Inductive Waveform**



**Fig. 3: Test Circuit For Inductive Load Switching And Diode Recovery Times**

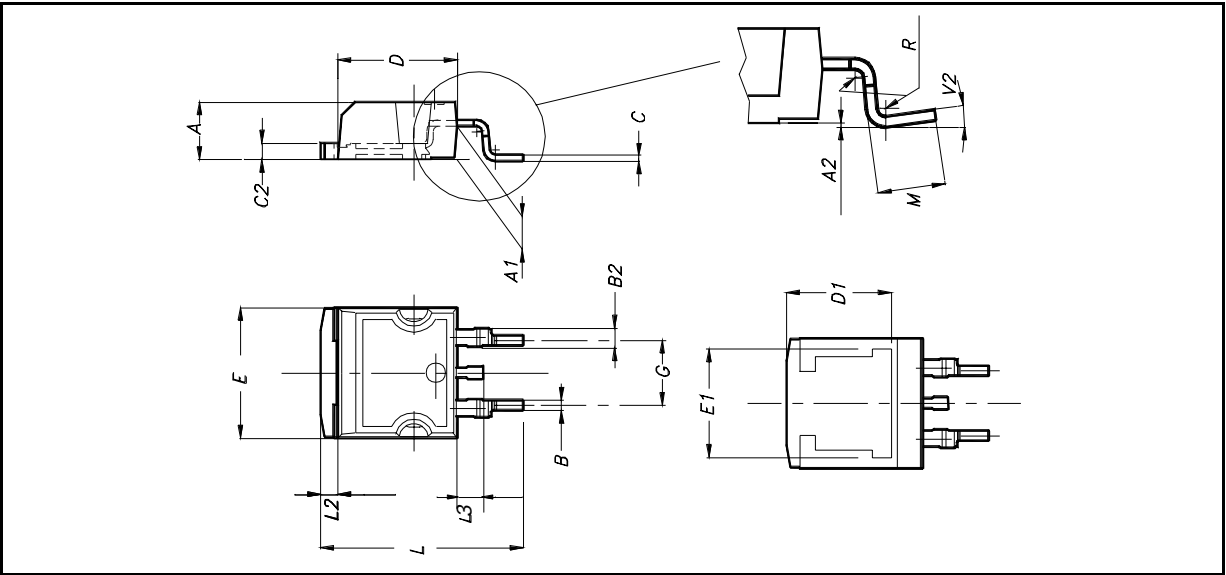


**Fig. 4: Gate Charge test Circuit**



D<sup>2</sup>PAK MECHANICAL DATA

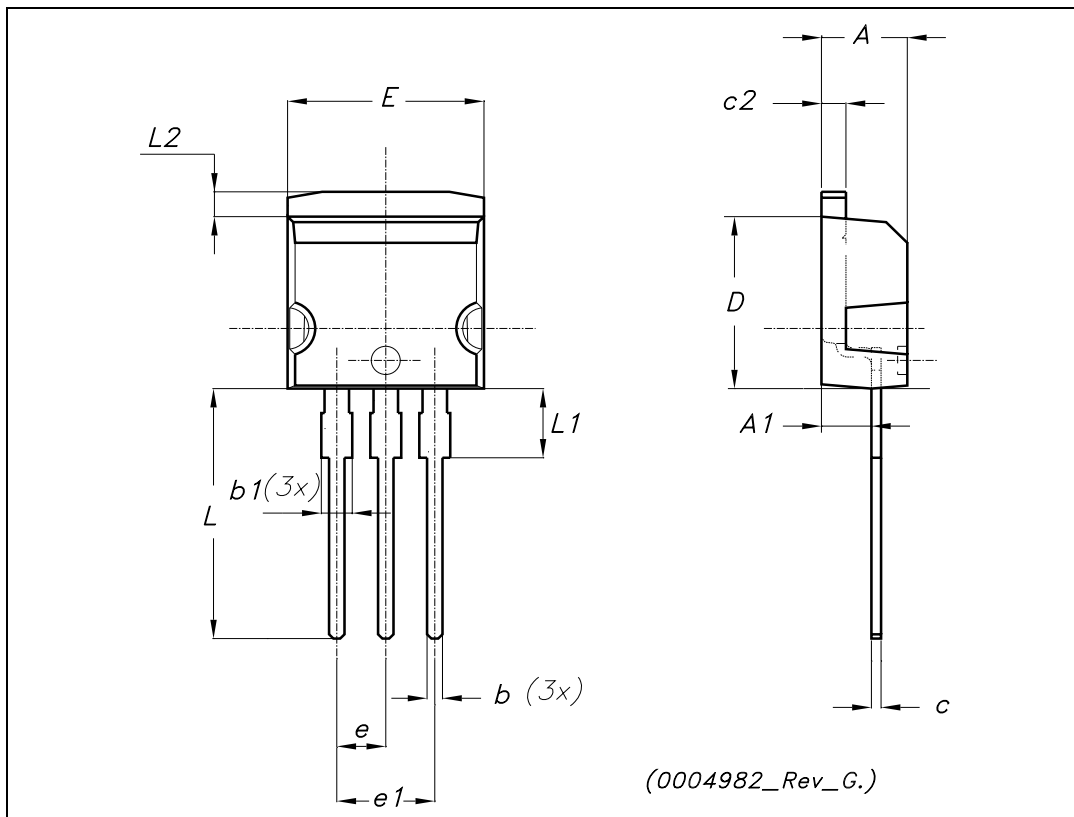
| DIM. | mm.  |     |       | inch  |       |       |
|------|------|-----|-------|-------|-------|-------|
|      | MIN. | TYP | MAX.  | MIN.  | TYP.  | MAX.  |
| A    | 4.4  |     | 4.6   | 0.173 |       | 0.181 |
| A1   | 2.49 |     | 2.69  | 0.098 |       | 0.106 |
| A2   | 0.03 |     | 0.23  | 0.001 |       | 0.009 |
| B    | 0.7  |     | 0.93  | 0.027 |       | 0.036 |
| B2   | 1.14 |     | 1.7   | 0.044 |       | 0.067 |
| C    | 0.45 |     | 0.6   | 0.017 |       | 0.023 |
| C2   | 1.23 |     | 1.36  | 0.048 |       | 0.053 |
| D    | 8.95 |     | 9.35  | 0.352 |       | 0.368 |
| D1   |      | 8   |       |       | 0.315 |       |
| E    | 10   |     | 10.4  | 0.393 |       |       |
| E1   |      | 8.5 |       |       | 0.334 |       |
| G    | 4.88 |     | 5.28  | 0.192 |       | 0.208 |
| L    | 15   |     | 15.85 | 0.590 |       | 0.625 |
| L2   | 1.27 |     | 1.4   | 0.050 |       | 0.055 |
| L3   | 1.4  |     | 1.75  | 0.055 |       | 0.068 |
| M    | 2.4  |     | 3.2   | 0.094 |       | 0.126 |
| R    |      | 0.4 |       |       | 0.015 |       |
| V2   | 0°   |     | 8°    |       |       |       |



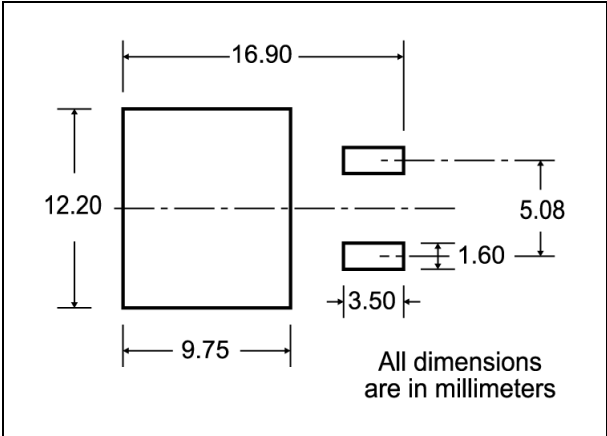


TO-262 (I<sup>2</sup>PAK) MECHANICAL DATA

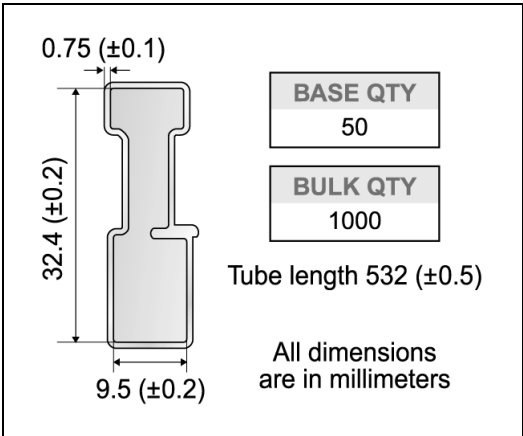
| DIM. | mm.  |     |       | inch  |      |       |
|------|------|-----|-------|-------|------|-------|
|      | MIN. | TYP | MAX.  | MIN.  | TYP. | MAX.  |
| A    | 4.40 |     | 4.60  | 0.173 |      | 0.181 |
| A1   | 2.40 |     | 2.72  | 0.094 |      | 0.107 |
| b    | 0.61 |     | 0.88  | 0.024 |      | 0.034 |
| b1   | 1.14 |     | 1.70  | 0.044 |      | 0.066 |
| c    | 0.49 |     | 0.70  | 0.019 |      | 0.027 |
| c2   | 1.23 |     | 1.32  | 0.048 |      | 0.052 |
| D    | 8.95 |     | 9.35  | 0.352 |      | 0.368 |
| e    | 2.40 |     | 2.70  | 0.094 |      | 0.106 |
| e1   | 4.95 |     | 5.15  | 0.194 |      | 0.202 |
| E    | 10   |     | 10.40 | 0.393 |      | 0.410 |
| L    | 13   |     | 14    | 0.511 |      | 0.551 |
| L1   | 3.50 |     | 3.93  | 0.137 |      | 0.154 |
| L2   | 1.27 |     | 1.40  | 0.050 |      | 0.055 |



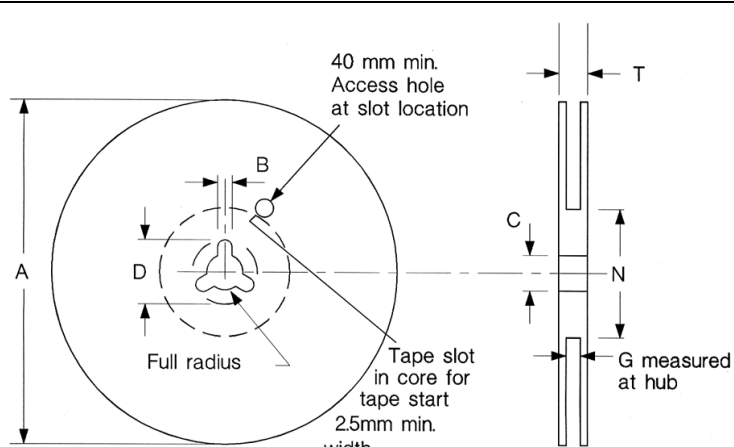
D<sup>2</sup>PAK FOOTPRINT



TUBE SHIPMENT (no suffix)\*



TAPE AND REEL SHIPMENT (suffix "T4")\*



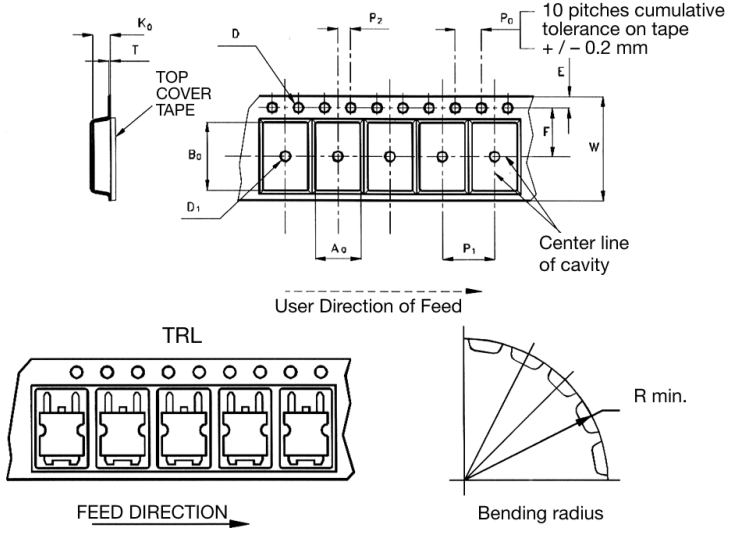
TAPE MECHANICAL DATA

| DIM. | mm   |      | inch   |        |
|------|------|------|--------|--------|
|      | MIN. | MAX. | MIN.   | MAX.   |
| A0   | 10.5 | 10.7 | 0.413  | 0.421  |
| B0   | 15.7 | 15.9 | 0.618  | 0.626  |
| D    | 1.5  | 1.6  | 0.059  | 0.063  |
| D1   | 1.59 | 1.61 | 0.062  | 0.063  |
| E    | 1.65 | 1.85 | 0.065  | 0.073  |
| F    | 11.4 | 11.6 | 0.449  | 0.456  |
| K0   | 4.8  | 5.0  | 0.189  | 0.197  |
| P0   | 3.9  | 4.1  | 0.153  | 0.161  |
| P1   | 11.9 | 12.1 | 0.468  | 0.476  |
| P2   | 1.9  | 2.1  | 0.075  | 0.082  |
| R    | 50   |      | 1.574  |        |
| T    | 0.25 | 0.35 | 0.0098 | 0.0137 |
| W    | 23.7 | 24.3 | 0.933  | 0.956  |

REEL MECHANICAL DATA

| DIM. | mm   |      | inch  |        |
|------|------|------|-------|--------|
|      | MIN. | MAX. | MIN.  | MAX.   |
| A    |      | 330  |       | 12.992 |
| B    | 1.5  |      | 0.059 |        |
| C    | 12.8 | 13.2 | 0.504 | 0.520  |
| D    | 20.2 |      | 0.795 |        |
| G    | 24.4 | 26.4 | 0.960 | 1.039  |
| N    | 100  |      | 3.937 |        |
| T    |      | 30.4 |       | 1.197  |

| BASE QTY | BULK QTY |
|----------|----------|
| 1000     | 1000     |



\* on sales type  
10/11

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